

<u>Description:</u> Giga-snaP BGA SMT Land Socket 400 position BGA surface mount land pattern to terminal pins (0.8mm centers, 20x20 array)

<u>Tolerances:</u> diameters ± 0.03 mm [± 0.001 "], PCB perimeters ± 0.13 mm [± 0.005 "], PCB thicknesses ± 0.13 mm [± 0.007 "], pitches (from true position) ± 0.08 mm [± 0.003 "], all other tolerances ± 0.13 mm [± 0.005 "] unless stated otherwise. Materials and specifications are subject to change without notice.

LS-BGA400H-61 Drawing		Status: Released	Scale: 6:1		Rev: C
Ŕ	© 2005 IRONWOOD ELECTRONICS, INC. Tele: (800) 404-0204 www.ironwoodelectronics.com	Drawing: S.Natarajan		Date: 5/11/05	
		File: LS-BGA400H-61 Dwg.mcd		Modified: 01/18/13, DH	